

承認書 Specification For Approval

Customer: (客戶)						
De	Description:(產品描述) SMD3528灯珠红普绿双色					
Part number:(產品型號) TJ-S3528UG1W9TLC2R7K-A5						
Date: (日期)						
Approved By: (客戶承認)						
Prepared By:(我司承認)						
	Approval	Check	Design	Sales		
	核准	審核		業務		

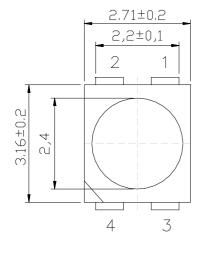
Customer Service Hotline: 400-676-8616

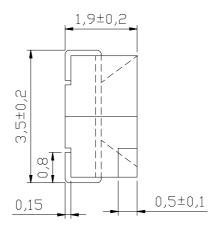
TEL: 0769-8662 5999 0769-8200 2226 FAX: 0769-8200 2227

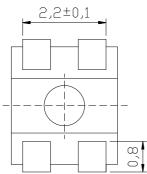
E-MIAL:dg@togialed.com WEB: www.togialed.com

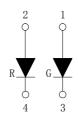


■ Outline Dimension:

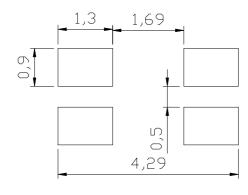








■ PAD Lay Out PCB





ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
SENSITIVE DEVICES

Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is ± 0.2 unless otherwise noted.
- 3. Specifications are subject to change without notice.

■ Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

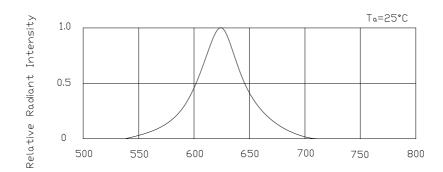
Items	Symbol	Absolute maximum Rating	Unit	
Power Dissipation	P_{D}	84	mW	
Forward Current(DC)	I_{F}	20	mA	
Peak Forward Current	${ m I}_{ m FP}$	60	mA	
Reverse Voltage	VR	5	V	
Operation Temperature	Topr	- 25∼ + 80	$^{\circ}$	
Storage Temperature	Tstg	- 30∼ + 85	°C	
Lead Soldering Temperature Tsol		Max.260°C for 5 sec Max. (3min from the base of the epoxy bulb)		

Pulse width ≤ 0.1 msec duty $\leq 1/10$

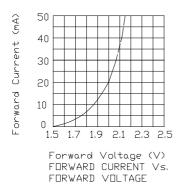
■ Typical Electrical & Optical Characteristics(Ta=25°)

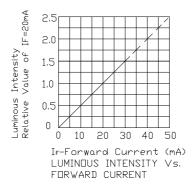
Items	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	VF (IF=20mA)	G	1.8	2.0	2.4	V
roiward voltage		R	1.8	2.0	2.4	V
Reverse Current	IR	VR =5V			2	μА
Dominant Wavelen oth	Λ d (I _F =20mA)	R	620		630	nm
Dominant Wavelength		G	565		575	nm
Luminous Intensity	Iv (I _F =20mA)	R	300	500		mcd
Luminous Intensity		G	50	100		mcd
View Angle	2 θ 1/2	I _F =20mA		120		Deg

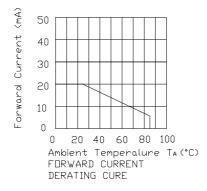
Typical Electrical/Optical Characteristics Curves (R):

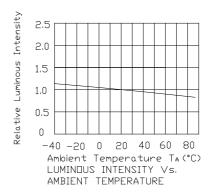


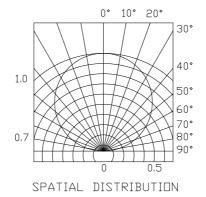
wavelength (nm)
RELATIVE INTENSITY Vs.WAVELENGTH



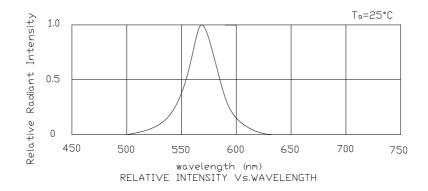


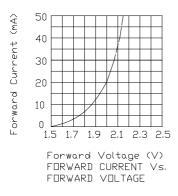


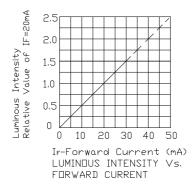


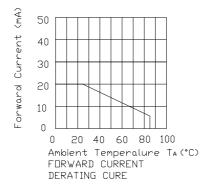


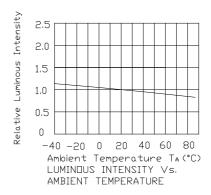
Typical Electrical/Optical Characteristics Curves (G):

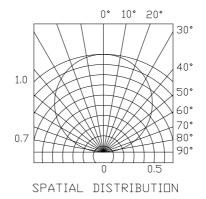












Test items and results of reliability

Туре	Test Item	Test Conditions	Note	Number of Damaged
	Temperature Cycle	-20°C 30min ↑ ↓ 80°C 30min	100 cycle	0/22
	Thermal Shock	-20℃ 15min ↑↓ 80℃ 15min	100 cycle	0/22
nental ence	High Humidity Heat Cycle	30℃⇔ 65℃ 90%RH 24hrs/1cycle	10 cycle	0/22
Environmental Sequence	High Temperature Storage Ta=80℃		1000 hrs	0/22
	Humidity Heat Storage	Ta=60℃ RH=90%	1000 hrs	0/22
	Low Temperature Storage	Ta=-30°C	1000 hrs	0/22
Operation Sequence	Life Test	Ta=25℃ IF=20mA	1000 hrs	0/22
	High Humidity Heat Life Test	60℃ RH=90% IF=10mA	500 hrs	0/22
	Low Temperature Life Test	Ta=-20℃ IF=20mA	1000 hrs	0/22

Soldering:

1. Manual Soldering

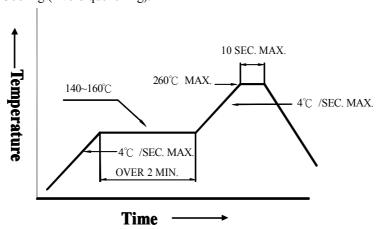
The temperature of the iron tip should not be higher than 350°C and Soldering time to be within 3 seconds per solder-pad.

2. Reflow Soldering

Preheating : $140\,^{\circ}\text{C} \sim 160\,^{\circ}\text{C} \pm 5\,^{\circ}\text{C}$, within 2 minutes.

Operation heating: 260°C (Max.) within 10 seconds.(Max)

Gradual Cooling (Avoid quenching).

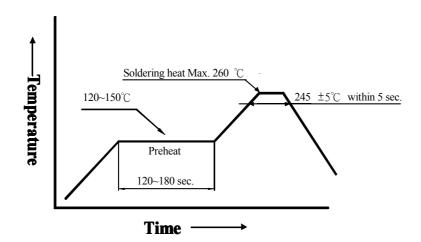


3. DIP soldering (Wave Soldering):

Preheating : $120\,^{\circ}\text{C} \sim 150\,^{\circ}\text{C}$, within $120 \sim 180$ sec.

Operation heating: 245 °C±5 °C within 5 sec.260 °C (Max)

Gradual Cooling (Avoid quenching).



• Handling:

Care must be taken not to damage LED's epoxy resin while exposing to high temperature or contact LED's epoxy resin with hard or sharp objects, such as metal hook, tweezer or sand blasting.

Notes for designing:

Current limiting resistor must be used in the circuit to drive TOGIA LEDs within the rated figures and not to overload TOGIA LEDs with instantaneous voltage at the turning ON and OFF cycles.

When using pulse driving, the average current must be within the rated figures. And the circuit should be designed to avoid reverse voltage when turning off the TOGIA LEDs.

Storage:

In order to avoid the absorption of moisture, it is recommended to solder TOGIA LEDs as soon as possible after unpacking the sealed envelope.

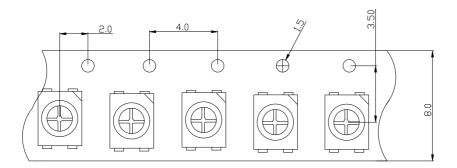
If the envelope is still packed, to store it in the environment as following:

- (1) Temperature : 5° C-30°C(41°F)Humidity : RH 60% Max.
- (2) After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow, or equivalent soldering process must be:
 - a. Completed within 168 hours.
 - b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if:
 - (2) a or (2) b is not met.
- (4) If baking is required, devices must be baked under below conditions:
 - 48 hours at $60^{\circ}\text{C} \pm 3^{\circ}\text{C}$.

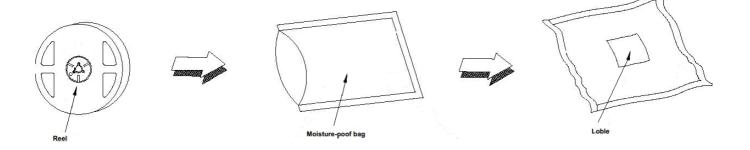
Package and Label of Products:

Package: Products are packed in one bag of 1000 pcs (one taping reel) and a label is attached to each bag.

● Tapping and packaging specifications(Units: mm)



Label Aluminum moisture-proof bag Desiccant Label



• Package Method unit: mm)

